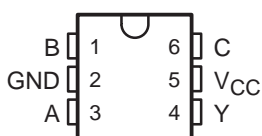
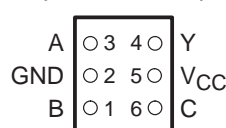


- Available in the Texas Instruments NanoStar™ and NanoFree™ Packages
- Single-Supply Voltage Translator
- Possible Translation Sequences
  - 1.8 V to 3.3 V
  - 2.5 V to 3.3 V
  - 1.8 V to 2.5 V
  - 3.3 V to 2.5 V
- Multiple Functions in Single Package
- I<sub>off</sub> Supports Partial-Power-Down Mode Operation
- Very Low Static and Dynamic Power Consumption
- Includes Schmitt-Trigger Inputs
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD 22
  - 2000-V Human-Body Model (A114-B, Class II)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

DBV OR DCK PACKAGE  
(TOP VIEW)



YEP OR YZP PACKAGE  
(BOTTOM VIEW)



## description/ordering information

The AUP family is TI's premier solution to the industry's low-power needs in battery-powered portable applications. This family ensures a very low static- and dynamic-power consumption across the entire  $V_{CC}$  range of 0.8 V to 3.6 V, resulting in increased battery life (see Figure 1). This product also maintains excellent signal integrity (see the very low undershoot and overshoot characteristics shown in Figure 2).

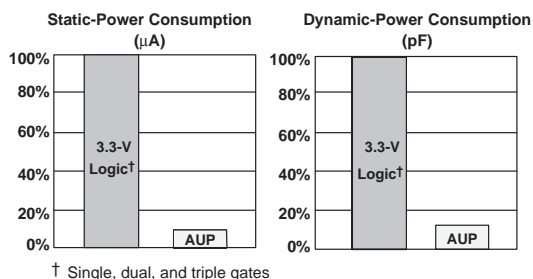


Figure 1. AUP – The Lowest-Power Family

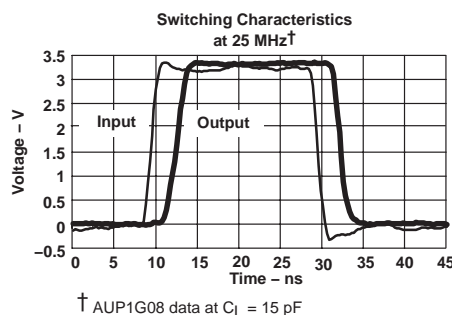


Figure 2. Excellent Signal Integrity

The SN74AUP1T98 features configurable multiple functions along with level-translation capability. The output state is determined by eight patterns of 3-bit input. The user can choose the logic functions MUX, AND, OR, NAND, NOR, inverter, and noninverter. All inputs can be connected to  $V_{CC}$  or GND.

The AUP1T98 is optimized to perform 1.8-V to 3.3-V translation. Since this device has only one supply-voltage pin, it eliminates the need for a second LDO to be routed to the level-translation device.

This device functions as an independent gate with Schmitt-trigger inputs, which allows for slow input transition and better switching noise immunity at the input.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

NanoStar and NanoFree are trademarks of Texas Instruments.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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# SN74AUP1T98

## SINGLE-SUPPLY VOLTAGE TRANSLATOR

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### description/ordering information (continued)

NanoStar™ and NanoFree™ package technology is a major breakthrough in IC packaging concepts, using the die as the package.

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

### ORDERING INFORMATION

TA	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING‡
–40°C to 85°C	NanoStar™ – WCSP (DSBGA) 0.23-mm Large Bump – YEP	Tape and reel	SN74AUP1T98YEPR	___TK_
	NanoFree™ – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb-free)	Tape and reel	SN74AUP1T98YZPR	
	SOT (SOT-23) – DBV	Tape and reel	SN74AUP1T98DBVR	HT6_
	SOT (SC-70) – DCK	Tape and reel	SN74AUP1T98DCKR	TK_

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

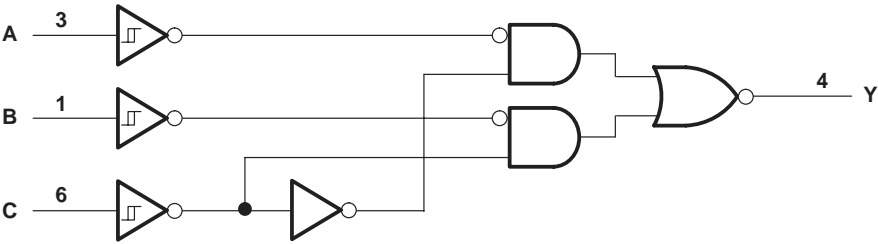
‡ DBV/DCK: The actual top-side marking has one additional character that designates the assembly/test site.

YEP/YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, • = Pb-free).

### FUNCTION TABLE

INPUTS			OUTPUT Y
C	B	A	
L	L	L	H
L	L	H	H
L	H	L	L
L	H	H	L
H	L	L	H
H	L	H	L
H	H	L	H
H	H	H	L

### logic diagram (positive logic)



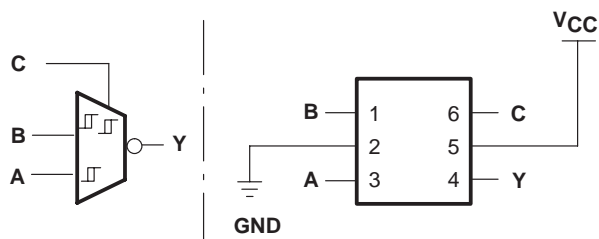
**FUNCTION SELECTION TABLE**

<b>LOGIC FUNCTION</b>	<b>FIGURE NO.</b>
2-to-1 data selector with inverted output	3
2-input NAND gate	4
2-input NOR gate with one inverted input	5
2-input AND gate with one inverted input	5
2-input NAND gate with one inverted input	6
2-input OR gate with one inverted input	6
2-input NOR gate	7
Noninverted buffer	8
Inverter	9

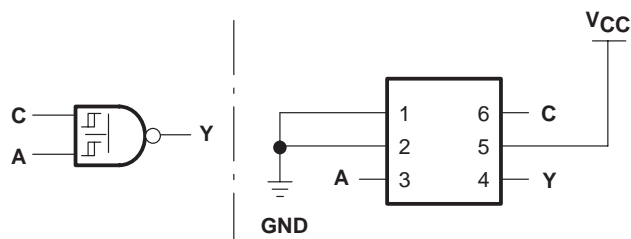
# SN74AUP1T98 SINGLE-SUPPLY VOLTAGE TRANSLATOR

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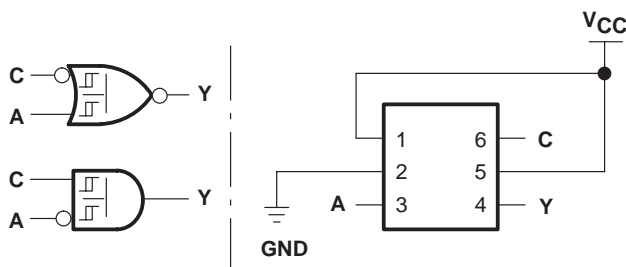
## logic configurations



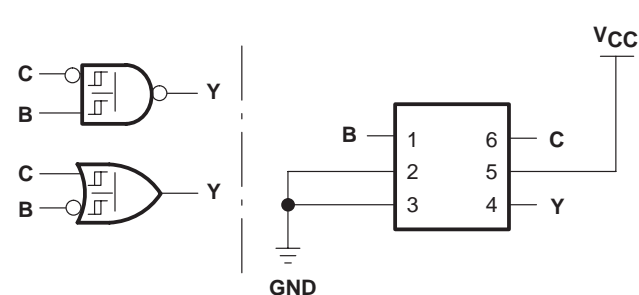
**Figure 3. 2-to-1 Data Selector  
With Inverted Output**  
When C is L,  $Y = \overline{B}$   
When C is H,  $Y = A$



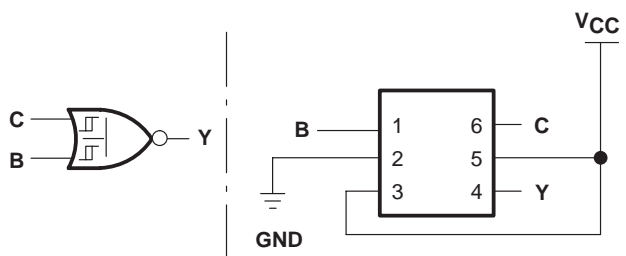
**Figure 4. 2-Input NAND Gate**



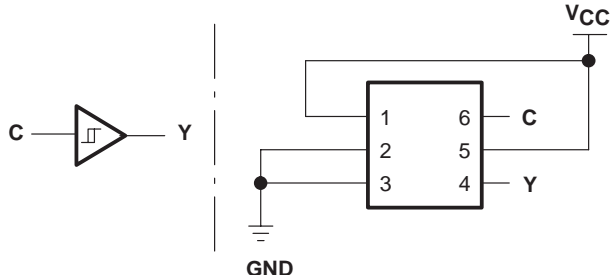
**Figure 5. 2-Input NOR Gate  
With One Inverted Input**  
2-Input AND Gate With One Inverted Input



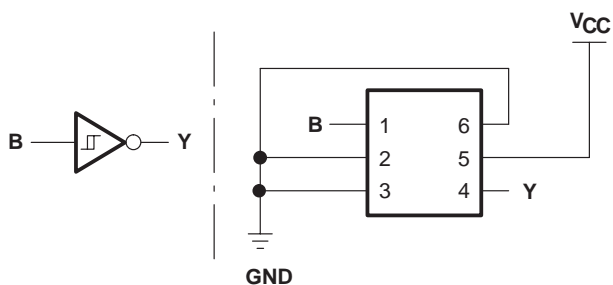
**Figure 6. 2-Input NAND Gate  
With One Inverted Input**  
2-Input OR Gate With One Inverted Input



**Figure 7. 2-Input NOR Gate**



**Figure 8. Noninverted Buffer**



**Figure 9. Inverter**

## 5

# SN74AUP1T98

## SINGLE-SUPPLY VOLTAGE TRANSLATOR

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**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER		TEST CONDITIONS	V <sub>CC</sub>	T <sub>A</sub> = 25°C			T <sub>A</sub> = -40°C TO 85°C		UNIT
				MIN	TYP	MAX	MIN	MAX	
V <sub>T+</sub> Positive-going input threshold voltage		2.3 V to 2.7 V	0.6		1.1	0.6	1.1	V	
		3 V to 3.6 V	0.75		1.16	0.75	1.19		
V <sub>T-</sub> Negative-going input threshold voltage		2.3 V to 2.7 V	0.35		0.6	0.35	0.6	V	
		3 V to 3.6 V	0.5		0.85	0.5	0.85		
ΔV <sub>T</sub> Hysteresis (V <sub>T+</sub> - V <sub>T-</sub> )		2.3 V to 2.7 V	0.23		0.6	0.2	0.6	V	
		3 V to 3.6 V	0.25		0.56	0.25	0.56		
V <sub>OH</sub>	I <sub>OH</sub> = -20 μA	2.3 V to 3.6 V	V <sub>CC</sub> - 0.1			V <sub>CC</sub> - 0.1		V	
	I <sub>OH</sub> = -2.3 mA	2.3 V	2.05			1.97			
	I <sub>OH</sub> = -3.1 mA		1.9			1.85			
	I <sub>OH</sub> = -2.7 mA		2.72			2.67			
	I <sub>OH</sub> = -4 mA	3 V	2.6			2.55			
V <sub>OL</sub>	I <sub>OL</sub> = 20 μA	2.3 V to 3.6 V	0.1			0.1		V	
	I <sub>OL</sub> = 2.3 mA	2.3 V	0.31			0.33			
	I <sub>OL</sub> = 3.1 mA		0.44			0.45			
	I <sub>OL</sub> = 2.7 mA		0.31			0.33			
	I <sub>OL</sub> = 4 mA	3 V	0.44			0.45			
I <sub>I</sub>	All inputs	V <sub>I</sub> = 3.6 V or GND	0 V to 3.6 V		0.1		0.5		μA
I <sub>off</sub>		V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V	0 V		0.1		0.5		μA
ΔI <sub>off</sub>		V <sub>I</sub> or V <sub>O</sub> = 5.5 V	0 V to 0.2 V		0.2		0.5		μA
I <sub>CC</sub>		V <sub>I</sub> = 3.6 V or GND, I <sub>O</sub> = 0	2.3 V to 3.6 V		0.5		0.9		μA
ΔI <sub>CC</sub>	One input at 0.3 V or 1.1 V, Other inputs at 0 or V <sub>CC</sub> , I <sub>O</sub> = 0	2.3 V to 2.7 V				4		μA	
	One input at 0.45 V or 1.2 V, Other inputs at 0 or V <sub>CC</sub> , I <sub>O</sub> = 0	3 V to 3.6 V				12			
C <sub>i</sub>		V <sub>I</sub> = V <sub>CC</sub> or GND	3.3 V		1.5				pF
C <sub>o</sub>		V <sub>O</sub> = V <sub>CC</sub> or GND	3.3 V		3				pF

**switching characteristics over recommended operating free-air temperature range, V<sub>CC</sub> = 2.5 V ± 0.2 V, V<sub>I</sub> = 1.8 V ± 0.15 V (unless otherwise noted) (see Figure 10)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C <sub>L</sub>	T <sub>A</sub> = 25°C			T <sub>A</sub> = -40°C TO 85°C		UNIT
				MIN	TYP	MAX	MIN	MAX	
t <sub>pd</sub>	A, B, or C	Y	5 pF	1.8	2.3	2.9	0.5	6.8	ns
			10 pF	2.3	2.8	3.4	1	7.9	
			15 pF	2.6	3.1	3.8	1	8.7	
			30 pF	3.8	4.4	5.1	1.5	10.8	



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## SINGLE-SUPPLY VOLTAGE TRANSLATOR

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switching characteristics over recommended operating free-air temperature range,  $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ ,  $V_I = 2.5\text{ V} \pm 0.2\text{ V}$  (unless otherwise noted) (see Figure 10)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$C_L$	$T_A = 25^\circ\text{C}$			$T_A = -40^\circ\text{C}$ TO $85^\circ\text{C}$		UNIT
				MIN	TYP	MAX	MIN	MAX	
$t_{pd}$	A, B, or C	Y	5 pF	1.8	2.3	3.1	0.5	6	ns
			10 pF	2.2	2.8	3.5	1	7.1	
			15 pF	2.6	3.2	5.2	1	7.9	
			30 pF	3.7	4.4	5.2	1.5	10	

switching characteristics over recommended operating free-air temperature range,  $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ ,  $V_I = 3.3\text{ V} \pm 0.3\text{ V}$  (unless otherwise noted) (see Figure 10)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$C_L$	$T_A = 25^\circ\text{C}$			$T_A = -40^\circ\text{C}$ TO $85^\circ\text{C}$		UNIT
				MIN	TYP	MAX	MIN	MAX	
$t_{pd}$	A, B, or C	Y	5 pF	2	2.7	3.5	0.5	5.5	ns
			10 pF	2.4	3.1	3.9	1	6.5	
			15 pF	2.8	3.5	4.3	1	7.4	
			30 pF	4	4.7	5.5	1.5	9.5	

switching characteristics over recommended operating free-air temperature range,  $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_I = 1.8\text{ V} \pm 0.15\text{ V}$  (unless otherwise noted) (see Figure 10)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$C_L$	$T_A = 25^\circ\text{C}$			$T_A = -40^\circ\text{C}$ TO $85^\circ\text{C}$		UNIT
				MIN	TYP	MAX	MIN	MAX	
$t_{pd}$	A, B, or C	Y	5 pF	1.6	2	2.5	0.5	8	ns
			10 pF	2	2.4	2.9	1	8.5	
			15 pF	2.3	2.8	3.3	1	9.1	
			30 pF	3.4	3.9	4.4	1.5	9.8	

switching characteristics over recommended operating free-air temperature range,  $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_I = 2.5\text{ V} \pm 0.2\text{ V}$  (unless otherwise noted) (see Figure 10)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$C_L$	$T_A = 25^\circ\text{C}$			$T_A = -40^\circ\text{C}$ TO $85^\circ\text{C}$		UNIT
				MIN	TYP	MAX	MIN	MAX	
$t_{pd}$	A, B, or C	Y	5 pF	1.6	1.9	2.4	0.5	5.3	ns
			10 pF	2	2.3	2.7	1	6.1	
			15 pF	2.3	2.7	3.1	1	6.8	
			30 pF	3.4	3.8	4.2	1.5	8.5	



# SN74AUP1T98

## SINGLE-SUPPLY VOLTAGE TRANSLATOR

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switching characteristics over recommended operating free-air temperature range,  $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_I = 3.3\text{ V} \pm 0.3\text{ V}$  (unless otherwise noted) (see Figure 10)

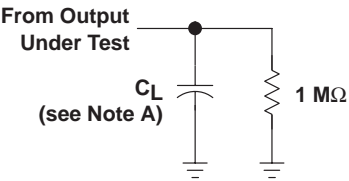
PARAMETER	FROM (INPUT)	TO (OUTPUT)	$C_L$	$T_A = 25^\circ\text{C}$			$T_A = -40^\circ\text{C}$ TO $85^\circ\text{C}$		UNIT
				MIN	TYP	MAX	MIN	MAX	
$t_{pd}$	A, B, or C	Y	5 pF	1.6	2.1	2.7	0.5	4.7	ns
			10 pF	2	2.4	3	1	5.7	
			15 pF	2.3	2.7	3.3	1	6.2	
			30 pF	3.4	3.8	4.4	1.5	7.8	

operating characteristics,  $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	$V_{CC} = 2.5\text{ V}$	$V_{CC} = 3.3\text{ V}$	UNIT
			TYP	TYP	
$C_{pd}$	Power dissipation capacitance	$f = 10\text{ MHz}$	4	5	pF

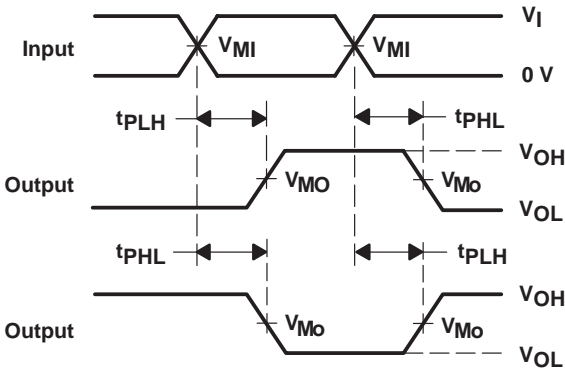


PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT

	$V_{CC} = 2.5\text{ V}$ $\pm 0.2\text{ V}$	$V_{CC} = 3.3\text{ V}$ $\pm 0.3\text{ V}$
$C_L$	5, 10, 15, 30 pF	5, 10, 15, 30 pF
$V_{MI}$	$V_I/2$	$V_I/2$
$V_{MO}$	$V_{CC}/2$	$V_{CC}/2$



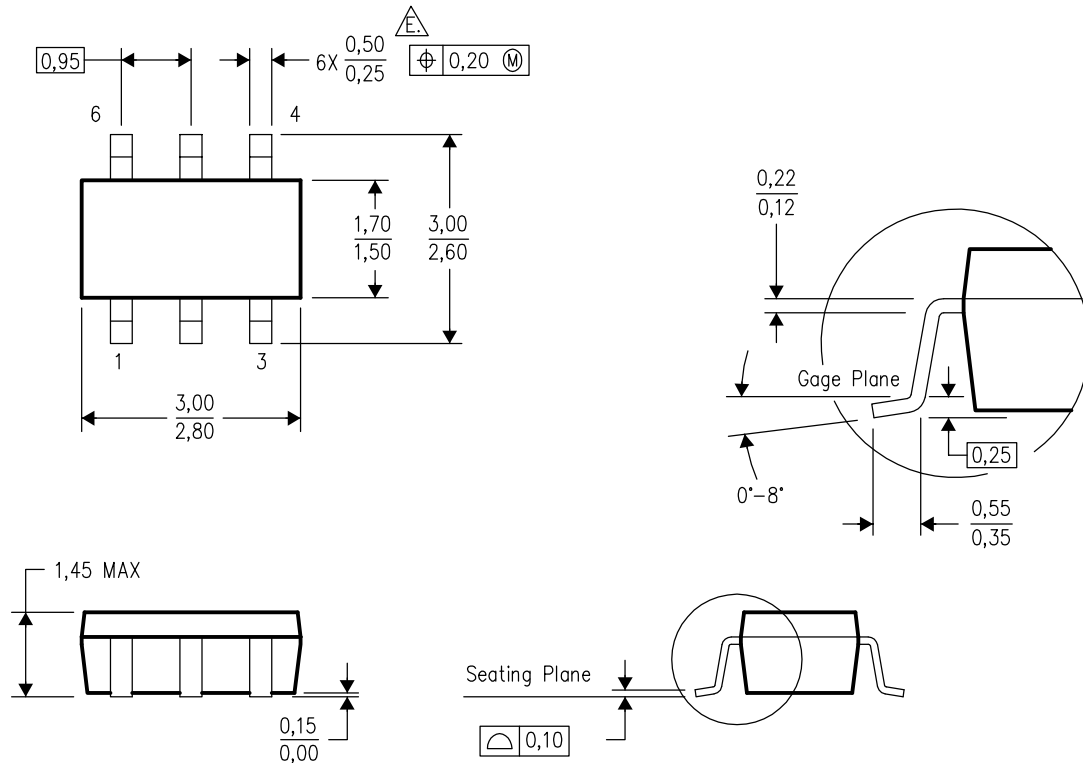
VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ , slew rate  $\geq 1\text{ V/ns}$ .  
C. The outputs are measured one at a time, with one transition per measurement.  
D.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .


Figure 10. Load Circuit and Voltage Waveforms

## DBV (R-PDSO-G6)

## PLASTIC SMALL-OUTLINE PACKAGE

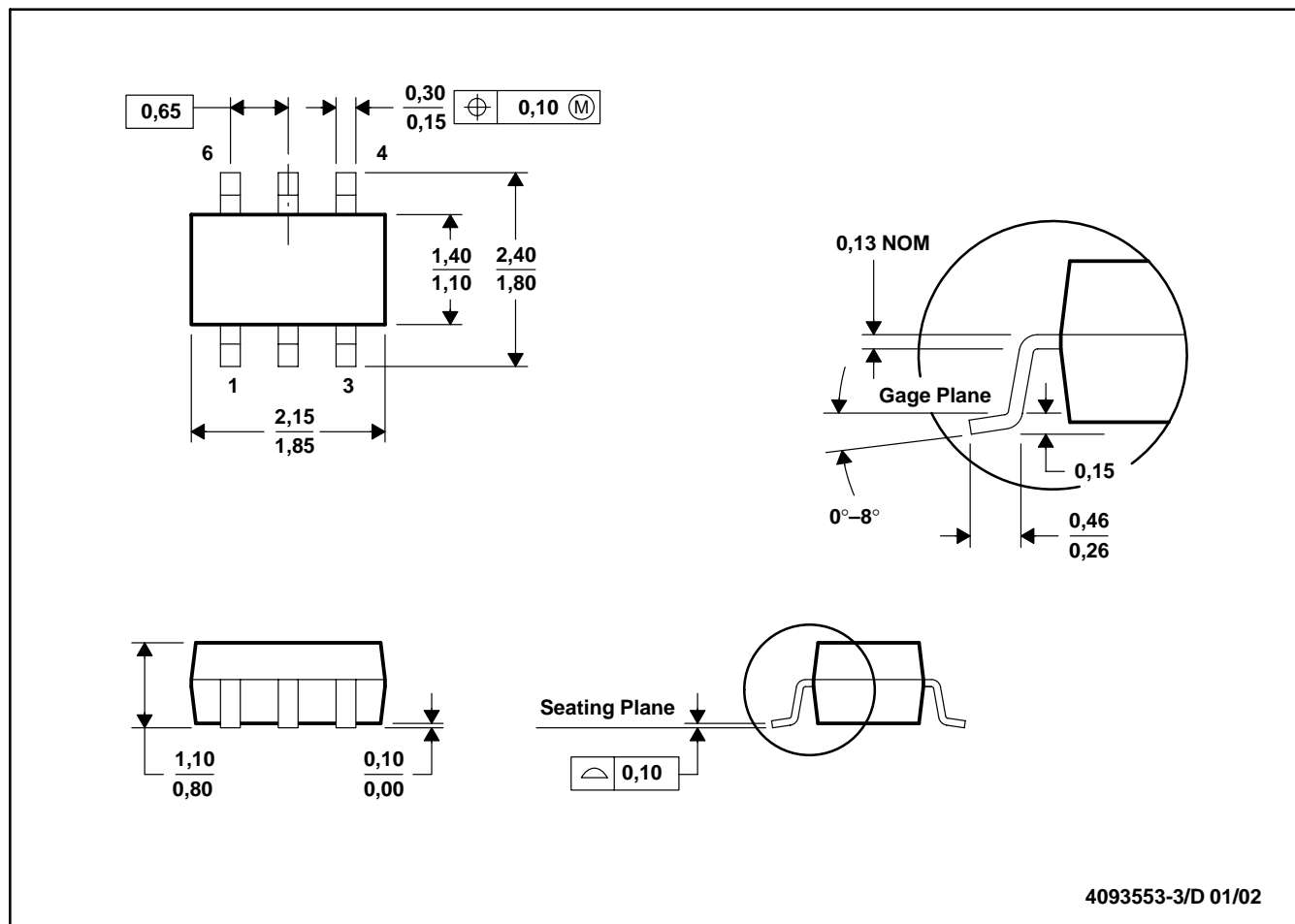


4073253-5/H 10/2003

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion.
  - D. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
  -  Falls within JEDEC MO-178 Variation AB, except minimum lead width.

## DCK (R-PDSO-G6)

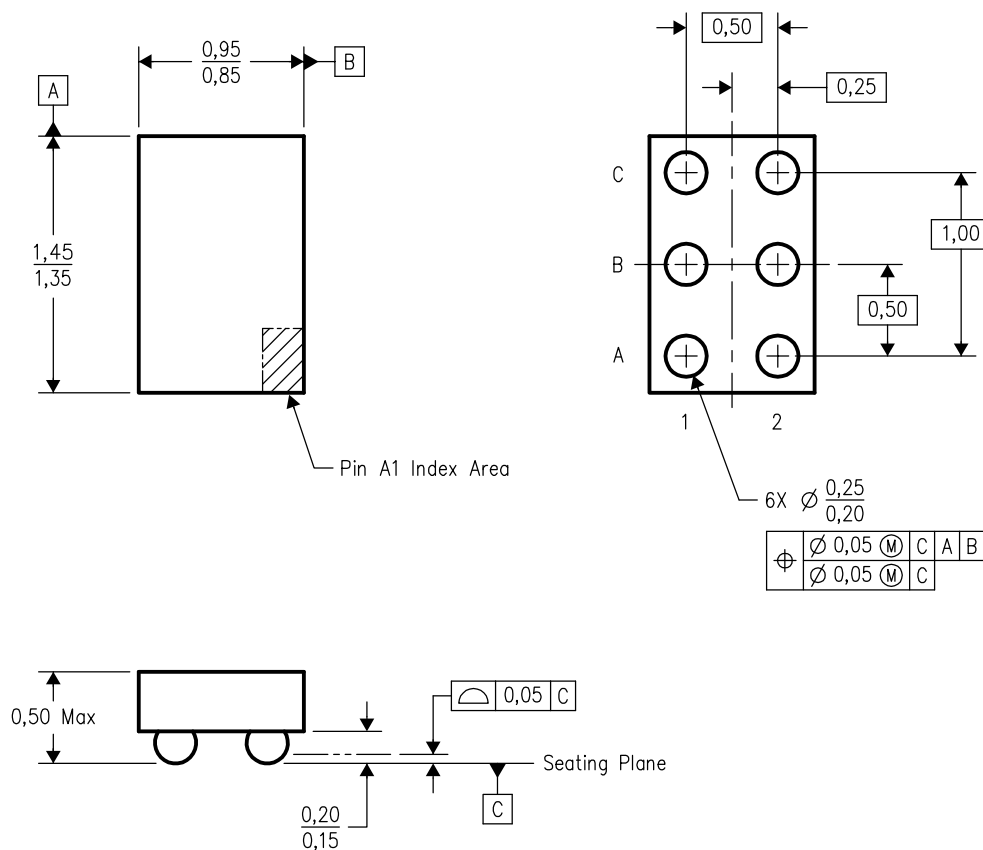
## PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion.
  - Falls within JEDEC MO-203

## YZP (R-XBGA-N6)

## DIE-SIZE BALL GRID ARRAY



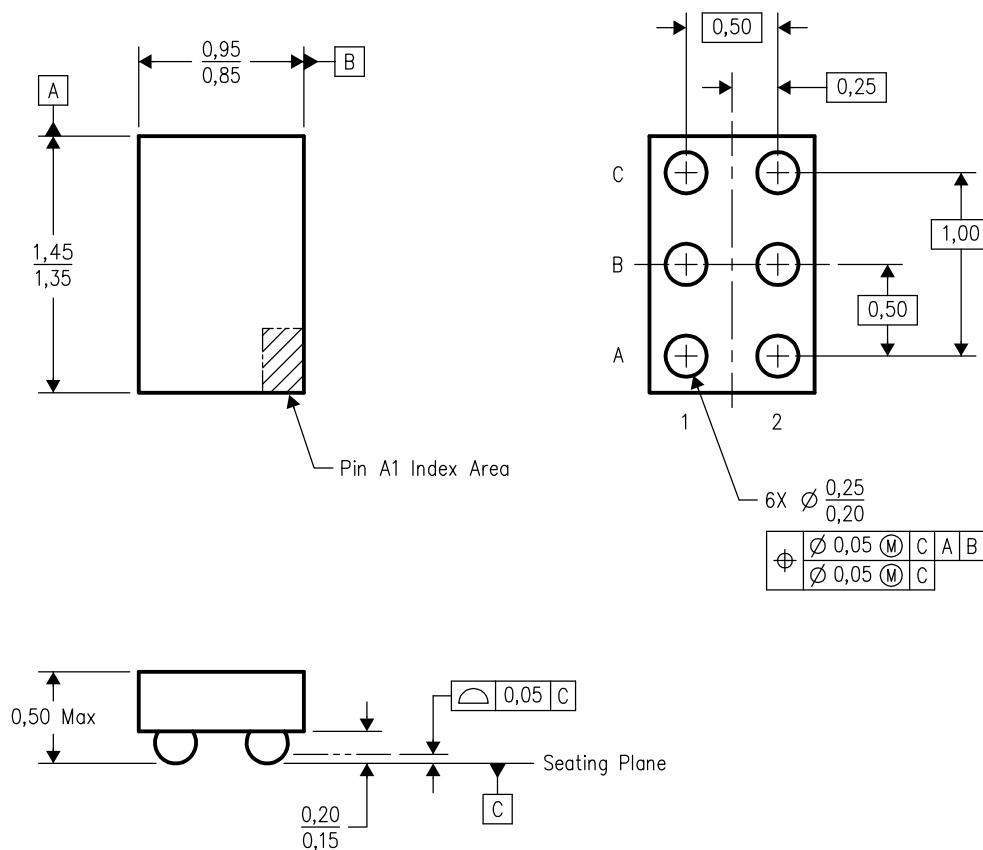
4204741-3/A 10/2002

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. NanoFree™ package configuration.
  - D. This package is lead-free. Refer to the 6 YEP package (drawing 4204725) for tin-lead (SnPb).

NanoFree is a trademark of Texas Instruments.

YEP (R-XBGA-N6)

DIE-SIZE BALL GRID ARRAY



4204725-3/A 10/2002

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. NanoStar™ package configuration.
  - D. This package is tin-lead (SnPb). Refer to the 6 YZP package (drawing 4204741) for lead-free.

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DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>	Broadband	<a href="http://www.ti.com/broadband">www.ti.com/broadband</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>	Digital Control	<a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>	Military	<a href="http://www.ti.com/military">www.ti.com/military</a>
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Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>	Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
		Telephony	<a href="http://www.ti.com/telephony">www.ti.com/telephony</a>
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